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MOSFET - Power, Single N-Channel, PQFN8

80 V, 32 A

NTMFS006N08MC

Features

- Advanced Package (5x6mm) with Excellent Thermal Conduction
- Ultra Low R_{DS(on)} to Improve System Efficiency
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Hot Swap Application
- Power Load Switch
- Battery Management and Protection

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	80	V	
Gate-to-Source Voltag	Gate-to-Source Voltage			±20	V	
Continuous Drain		$T_C = 25^{\circ}C$	I _D	82	Α	
Current R _{0JC} (Note 3)	Steady	T _C =85°C		59		
Power Dissipation $R_{\theta JC}$ (Note 3)	State	T _C = 25°C	P _D	78	W	
Continuous Drain		T _A = 25°C	۱ _D	14.7	Α	
Current R _{θJA} (Notes 1, 3)		T _A = 85°C		10.6		
Power Dissipation $R_{\theta JA}$ (Notes 1, 3)	Steady	$T_A = 25^{\circ}C$	PD	2.5	W	
Continuous Drain	State	T _A = 25°C	۱ _D	9.3	Α	
Current R _{θJA} (Notes 2, 3)		T _A = 85°C		6.7		
Power Dissipation $R_{\theta JA}$ (Notes 2, 3)		$T_A = 25^{\circ}C$	PD	1.0	W	
Pulsed Drain Current	$T_A = 25^{\circ}C$, $t_p = 10 \ \mu s$		I _{DM}	216	А	
Single Pulse Drain-to-Source Avalanche Energy ($I_L = 32 A_{pk}$)			E _{AS}	51	mJ	
Operating Junction and Storage Temperature Range			T _J , T _{STG}	–55 to +150	°C	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using 1 in² pad, 2 oz Cu pad.

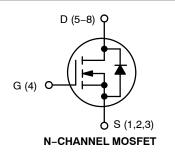
- 2. Surface-mounted on FR4 board using minimum pad size, 2 oz Cu pad.
- 3. The entire application environment impacts the thermal resistance values shown,
- they are not constants and are only valid for the particular conditions noted.

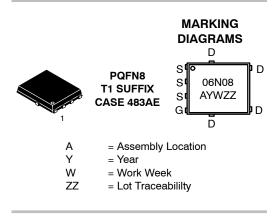


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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
80 V	6.0 mΩ @ 10 V	32 A
80 V	17 m Ω @ 6 V	16 A





ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.61	
Junction-to-Ambient - Steady State (Note 4)	R_{\thetaJA}	50	°C/W
Junction-to-Ambient - Steady State (Note 5)	$R_{\theta JA}$	125	

Surface-mounted on FR4 board using 1 in² pad, 2 oz Cu pad.
Surface-mounted on FR4 board using minimum pad size, 2 oz Cu pad.

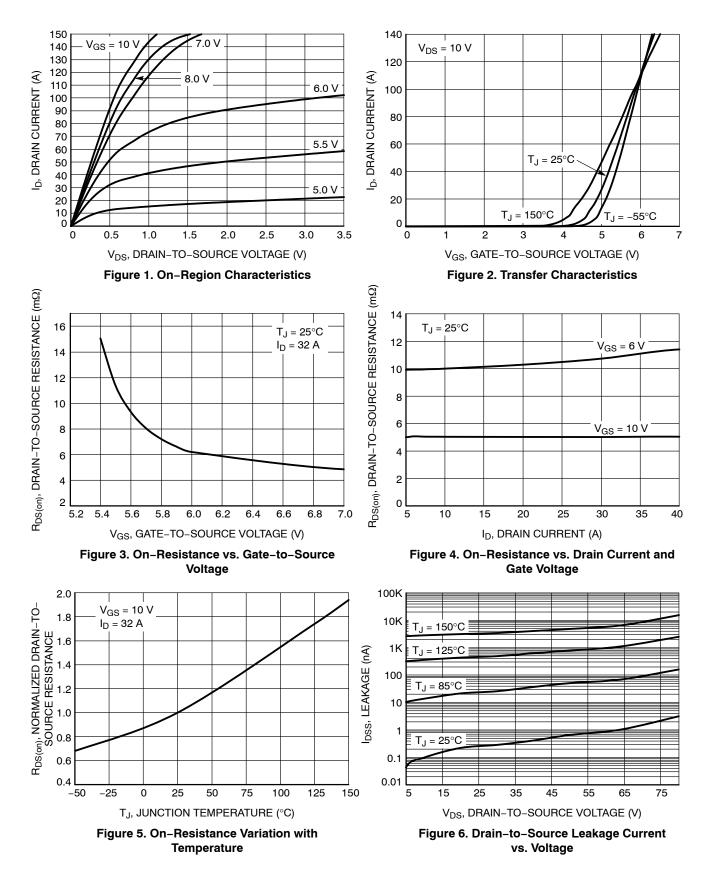
ELECTRICAL CHARACTERISTICS (T₁ = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	-			-	-		-
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		80			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J	I_D = 250 µA. ref to 25°C			96.6		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$ $T_J = 25^{\circ}C$				1.0	
		V _{DS} = 64 V	T _J = 125°C			100	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(TH)}	V_{GS} = V_{DS} , I_D = 250 μ A		2.0		4.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J	$I_D = 200 \ \mu A. ref to 25^{\circ}C$			-5		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 32 A		4.9	6.0	mΩ
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 6 V	I _D = 16 A		10.2	17	mΩ
Gate Resistance	R _G	T _A = 25°C			0.3		Ω
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, V _{DS} = 40 V, f = 1 MHz			2300		pF
Output Capacitance	C _{OSS}				710		
Reverse Transfer Capacitance	C _{RSS}				31		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 40 V; I _D = 32 A			30		nC
Threshold Gate Charge	Q _{G(TH)}				3.3		
Gate-to-Source Charge	Q _{GS}				10		
Gate-to-Drain Charge	Q _{GD}				6.0		
SWITCHING CHARACTERISTICS (Note 7	7)						
Turn-On Delay Time	t _{d(ON)}	V _{GS} = 10 V, V _{DS} = 15 V, I _D = 32 A, R _G = 2.5 Ω			13		ns
Rise Time	t _r				4		
Turn-Off Delay Time	t _{d(OFF)}				18		
Fall Time	t _f				4		
DRAIN-SOURCE DIODE CHARACTERIS	STICS			-		-	-
Forward Diode Voltage	Voltage V _{SD}	$V_{GS} = 0 V$, $T_J = 25^{\circ}C$		0.84	1.2		
		$I_{\rm S} = 32 \rm A$	$T_J = 125^{\circ}C$		0.78		V
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, dIS/dt = 100 A/µs, I_S = 32 A			49.58		ns
Reverse Recovery Charge	Q _{RR}				51.4		nC

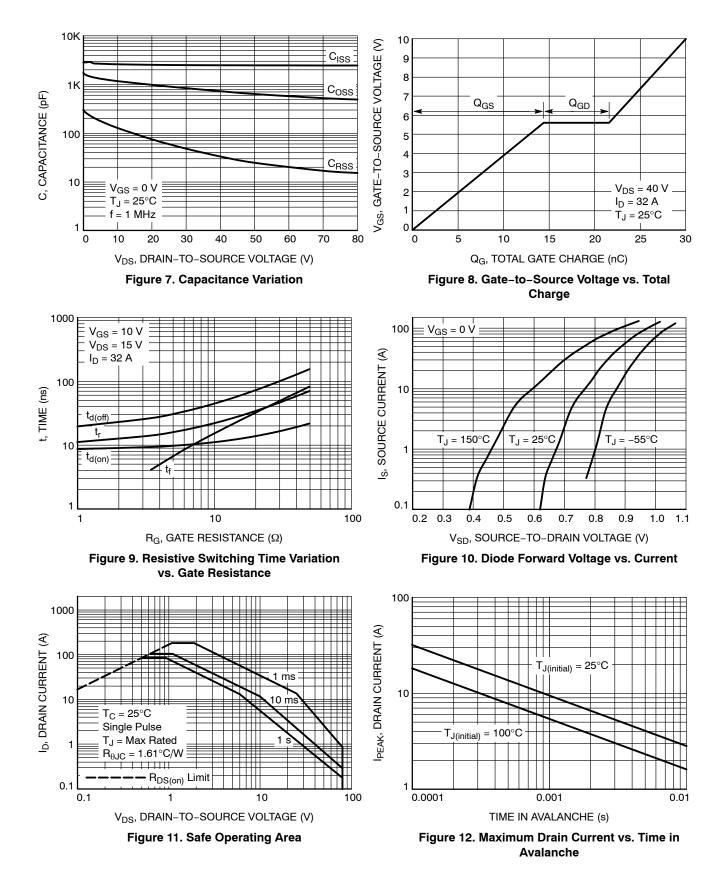
6. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%.

7. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

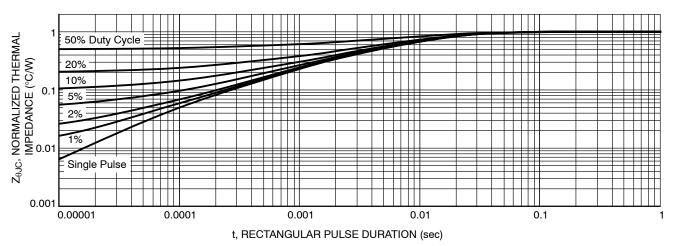


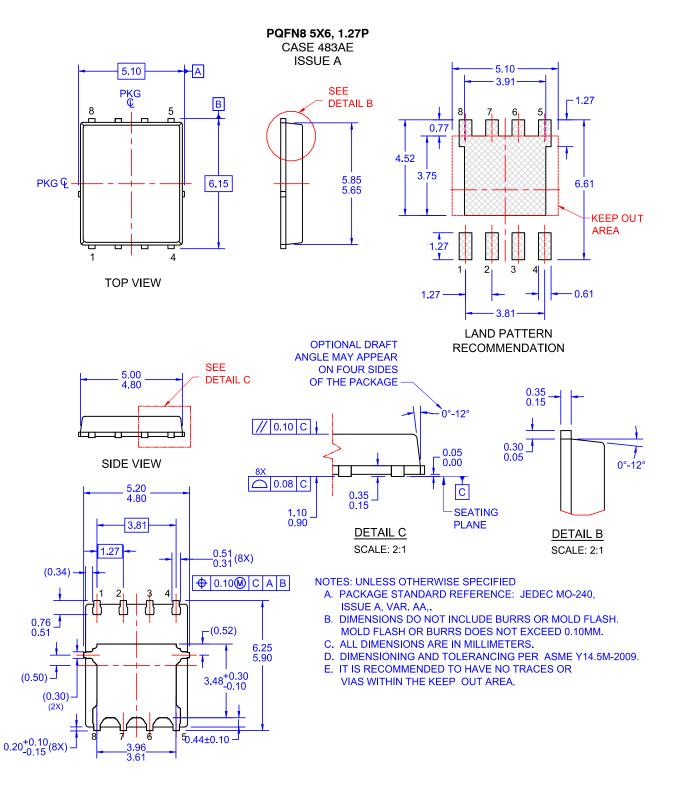
Figure 13. Transient Thermal Response

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMFS006N08MC	06N08	PQFN8 (Pb–Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



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